

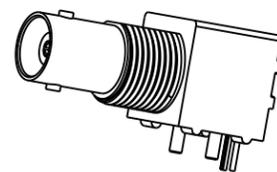
NOTES:

1. MATERIALS AND FINISHES:
 BODY - ZINC DIE CAST, NICKEL PLATING
 CONTACT - PHOSPHOR BRONZE, GOLD PLATING (.000003" THICK)
 AT CONTACT AREA ONLY, TIN PLATING AT TAIL, NICKEL PLATED OVERALL
 INSULATOR - POLYPROPYLENE
 HOUSING - PBT 15% G.F., WHITE
 ROUND PIN - BRASS, TIN PLATING
 GROUNDING TERMINAL - STEEL, TIN PLATING
2. ELECTRICAL:
 A. IMPEDANCE: 50 OHM
 B. FREQUENCY RANGE: DC - 1 GHz
 C. DIELECTRIC WITHSTANDING VOLTAGE: 1500 VRMS, MIN.
3. MECHANICAL:
 A. DURABILITY: 500 CYCLES MIN.
 B. TEMPERATURE RANGE: -55° C TO 85° C
4. PACKAGING:
 A. PACKAGED IN PACKING TRAYS
 B. QUANTITY PER TRAY: 40
 C. HEX NUT AND LOCKWASHER PACKAGED LOOSE
5. SUPPLIED MOUNTING HARDWARE
 TO BE TIGHTENED TO 10 IN-LBS MIN/15 IN-LBS MAX
 WHEN ASSEMBLING TO PANEL

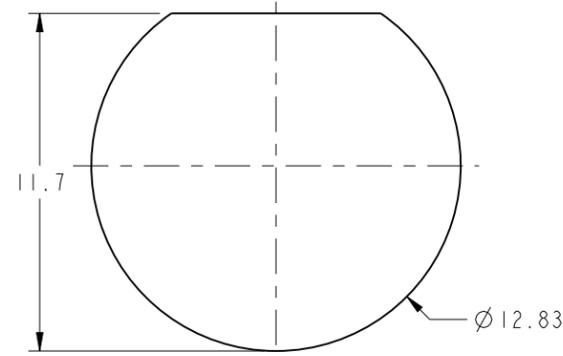
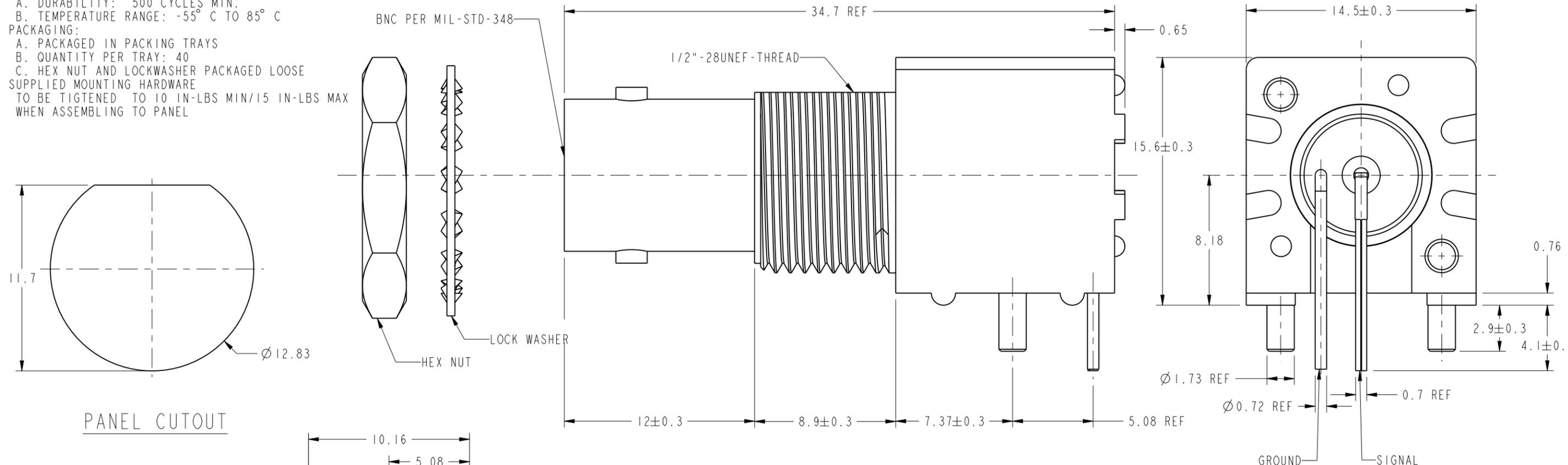
THIRD ANGLE PROJ.

REVISIONS

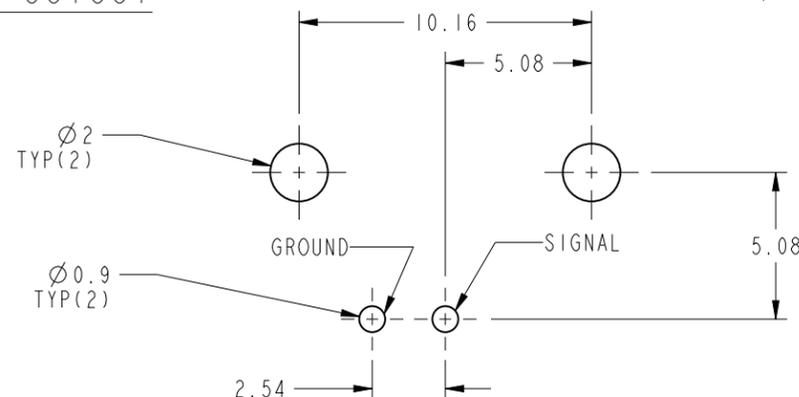
REV	DESCRIPTION	DATE	ECO	APPR
A	RELEASE TO MFG.	6/27/89	36598	DR
J	REDRAWN WAS SIZE 'C', DEL NOTE 1 THRU 4; ADD NOTES 8 THRU 10 & PLATE CODES; DEL ITEMS 2 THRU 4; ITEM 1 WAS 12382	11/27/96	41683	CPM/
K	ITEM 5 WAS 31-12070-TP	8/26/05	45703	CPM/
L	UPDATED FORMAT AND NOMINAL ENVELOPE DIMENSIONS	11/29/12	49265	EW
M	ADDED PICTURES OF SUPPLIED HARDWARE	7/15/13	49574	EW
N	AT WAS @, REARRANGED VIEWS, RELEASED AT ARFA	8/27/13	49702	EW



SCALE 1.000



PANEL CUTOUT



RECOMMENDED PCB LAYOUT

CUSTOMER OUTLINE DRAWING

ALL OTHER SHEETS ARE FOR INTERNAL USE ONLY

UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN METRIC AND TOLERANCES ARE:
 <0.5mm ±0.05mm 0.5 - 6mm ±0.1mm 6 - 30mm ±0.2mm 30 - 120mm ±0.3mm ANGLES ±1°

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MATERIAL SEE NOTES	DRAWN ERIC WANKOFF	DATE 20-Jun-12
REFERENCE	ENGINEER D ROYCE	DATE 2/1/90
CONFIGURATION LEVEL:	APPROVED D ROYCE	DATE 2/1/90
FINISH	CAD FILE	

TITLE 50 OHM BNC R/A JACK, ISOLATED W/ HARDWARE
SCALE: 4.0:1.0 SHEET 2 OF 2
DWG SIZE B
REV N

Amphenol RF www.amphenolrf.com	
DRAWING NO. 31-5431-2010	
ITEM NO. 31-5431-2010	
PART NO. 31-5431-2010	